PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

	:	NEW ASSIGNMENT			
NATURE OF CONV	EYANCE:	ASSIGNMENT	ASSIGNMENT		
CONVEYING PART	Y DATA				
		Execution Date			
Asif Imroz Mohamm	nad	06/18/2013			
Lae-Hoon Kim		06/18/2013			
Erik Visser			06/06/2013		
RECEIVING PARTY	DATA				
Name:		prporated			
Street Address:	5775 Morehouse	Drive			
City:	San Diego				
State/Country:	CALIFORNIA				
Postal Code:	92121-1714				
Property	Туре	Number	r		
Bronorty	Turna	Numbo	-		
Property Application Number		Number 33005	r		
Application Number	r: 139		r		
	r: 139 r: 617	33005	r		
Application Number	r: 139 r: 617 r: 616	33005 39662	r		
Application Number Application Number Application Number	r: 139 r: 617 r: 616 r: 616	33005 39662 81474	r		
Application Number Application Number Application Number Application Number CORRESPONDENC	r: 139 r: 617 r: 616 r: 616 r: 616 CE DATA 8016062774 <i>I be sent via US Main</i> 801-537-170 wla-admin@ te: Wesley L. At 170 S. Main	33005 39662 81474 67249 <i>when the fax attempt is unsuccessfu</i> 00 gaustin-rapp.com			
Application Number Application Number Application Number Application Number CORRESPONDENC Fax Number: <i>Correspondence win</i> Phone: Email: Correspondent Nam Address Line 1:	r: 139 r: 617 r: 616 r: 616 r: 616 CE DATA 8016062774 <i>I be sent via US Maii</i> 801-537-170 wla-admin@ re: Wesley L. Ai 170 S. Main Salt Lake Ci	33005 39662 81474 67249 <i>when the fax attempt is unsuccessfu</i> 00 gaustin-rapp.com ustin St., Ste. 735			
Application Number Application Number Application Number Application Number CORRESPONDENC Fax Number: <i>Correspondence wit</i> Phone: Email: Correspondent Nam Address Line 1: Address Line 4:	139 r: 617 r: 616 r: 8016062774 # be sent via US Main 801-537-170 wla-admin@ wla-admin@ # Wesley L. At 170 S. Main Salt Lake Ci ET NUMBER:	33005 39662 81474 67249 <i>when the fax attempt is unsuccessful</i> 00 yaustin-rapp.com ustin St., Ste. 735 ty, UTAH 84101			

Signature:	/Wesley L. Austin/
Date:	09/20/2013
Total Attachments: 4 source=130587_Assignment#page1.tif source=130587_Assignment#page2.tif source=130587_Assignment#page3.tif source=130587_Assignment#page4.tif	

PATENT QUALCOMM Ref. No. 130587 Page 1 of 3

ASSIGNMENT

WHEREAS, WE,

1. Asif I. Mohammad, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

2. Lae-Hoon Kim, a citizen of Korea, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

3. Erik Visser, a citizen of Luxembourg, having a mailing address located at 5775 Morchouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to SYSTEMS AND METHODS FOR SURROUND SOUND ECHO REDUCTION (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE. its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/933,005 filed 7/1/2013 . Qualcomm Reference No. 130587, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/739,662, filed December 19, 2012, Qualcomm Reference No. 130587P1, with U.S. Provisional Application No(s). 61/681,474, filed August 9, 2012. Qualcomm Reference No. 123328P1, with U.S. Provisional Application No(s). 61/667,249, filed July 2, 2012, Qualcomm Reference No. 123296P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \underline{SAN} <u>Ore 60</u>, on <u>061</u> (2013) LOCATION DATE

Asif I. Mohammad

PATENT REEL: 031250 FRAME: 0831

	PATENT QUALCOMM Ref. No. 130587 Page 3 of 3
Done at Son Disco, CA on 4/18/2013	
Done at San Diego, CA, on <u>6/18/2013</u> LOCATION DATE	Lae Hoon-Kim

Done at	, on		
		DATE	Erik Visser

PATENT QUALCOMM Ref. No. 130587 Page 3 of 3

Done at	, on				
-	LOCATION		DATE	Lae-Hoon Kim	
				0	
Done at	SAV DIE60	, 08	61612013	a and a second a se	
	LOCATION		DATE	/Erik Visser	

RECORDED: 09/20/2013